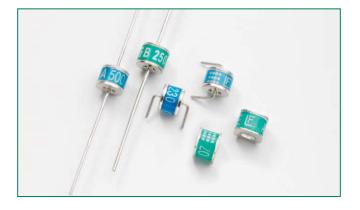
RoHS 🗭 SL1011A/B and SL1411A Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER
<i>L</i> R _®	E128662

2 Electrode GDT Graphical Symbol

ittelfuse

Expertise Applied | Answers Delivered



Description

The SL1011A/B and SL1411A series provides high levels of protection against fast rising transients in the $100V/\mu$ s to $1kV/\mu$ s range usually caused by lightning disturbances.

The SL1011A/B and SL1411A series offers low capacitance (< 1.5pf) which provides low insertion loss at high frequencies.

SL1011A offers 5kA protection without destruction whereas the SL1011B and SL1411A offer 10kA surge protection without destruction (maximum single surge of 12kA @ $8/20\mu$ s).

Features

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 5kA (SL1011A) or 10kA (SL1011B & SL1411A) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5

Applications

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment

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Gas Discharge Tube (GDT) Products SL1011A/B and SL1411A Series



Electrical Characteristics

	Device Specifications (at 25°C)				Life Ratings										
Part Number	ir	Breakc NVolts @100V/		Impulse Breakdown in Volts ³ (@100V/µs)	Impulse Breakdown In Volts (@1kV/µs)	Insulation Resistance	Capaci- tance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@100A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1s @50-60Hz)	AC Dischage Current (9 Cycles @ 50Hz)	DC Holdover Voltage⁴	Discharg	npulse e Current lication)
	MIN	TYP	MAX	MAX		MIN	MAX	ТҮР					ТҮР	@ 8/20µs	@ 10/350µs
SL1011A075															
SL1011B075	60	75	90	500	700										
SL1411A075						10 ¹⁰ Ω (at 50V)							50 V		
SL1011A090		90 10		500	600										
SL1011B090	72		108												
SL1411A090															
SL1011A145	116	145	174	500	650										
SL1011B145						- 1.5 pF - 10 ¹⁰ Ω - (at 100V)		.5 pF ~20 V	300 shots	SL1011A:	5 A 20 A SL1011B & SL1011E	SL1011B & SL1411A:		SL1011B & SL1411A: 12 kA	1 kA
SL1011A150	120	150 180	180	500	650										
SL1011B150 SL1011A230					700								k		
SL1011B230	18/	230 276	276	76 550						10 shots					
SL1411A230	104		270							(@5kA)					
SL1011A250							1.5 pF			SL1411A: SL					
SL1011B250	200	250 30	300	600	800										
SL1411A250															
SL1011A260				600	800										
SL1011B260	210	260 310	310												
SL1011A350		350 420		.0 800	900							135 V			
SL1011B350	280		420												
SL1411A350															
SL1011A470	376 470 564 1000 1100	70 504	1000	1100											
SL1411A470															
SL1011A500	400	500	600	1100	1200										
SL1011A600	480	600	720	1200	1400	00									
SL1411A600	100	500	120	1200	1400										

Notes:

1. At delivery AQL 0.65 level II, DIN ISO 2859

2. In ionized mode

3. Comparable to the silicon measurement Switching Voltage (Vs)

4. Tested according to ITU-T Rec. K.12 < 150 msecs.

Product Characteristics

Materials	Leaded Device: Nickel-plated with Tin- plated wires Core and Surface Mount: Dull Tin-plated
Product Marking	Littelfuse 'LF' Mark, voltage and date code

Glow to Arc Transition Current	< 0.5 Amps
Glow Voltage	~60 Volts
Storage and Operational Temperature	-40 to +90°C

SL1011A/B and SL1411A Series

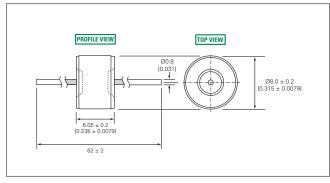


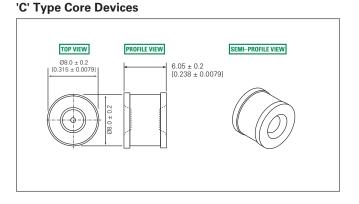
Gas Discharge Tube (GDT) Products SL1011A/B and SL1411A Series

Device Dimensions

For SL1011A/SL1011B series:

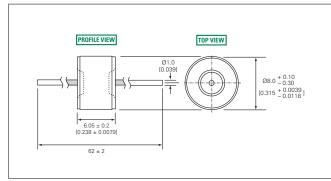
'A' Type Axial Lead Devices



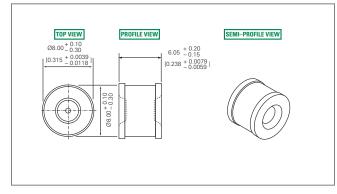


For SL1411A series:

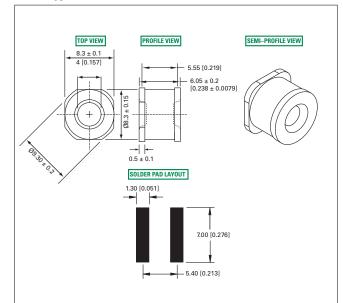
'A' Type Axial Lead Devices



'C' Type Core Devices



'SM' Type Surface Mount Devices

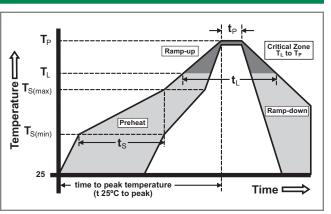


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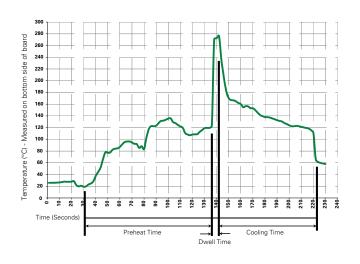


Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 seconds		
Average R (T _L) to pea	amp-up Rate (LiquidusTemp k)	3°C/second max.		
$T_{S(max)}$ to T_L	- Ramp-up Rate	5°C/second max.		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with Temperatu	in 5°C of Actual Peak ıre (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max.		
Time 25°C	to PeakTemperature (T _P)	8 minutes max.		
Do not exc	ceed	260°C		



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation		
Preheat:			
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder Dwell Time:	2-5 seconds		

Soldering Parameters - Hand Soldering

Solder Iron Temperature: 350° C +/- 5°C Heating Time: 5 seconds max.

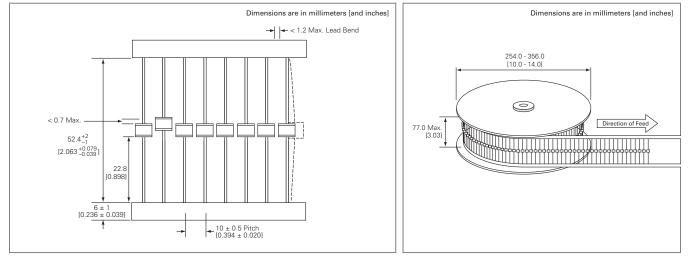
SL1011A/B and SL1411A Series



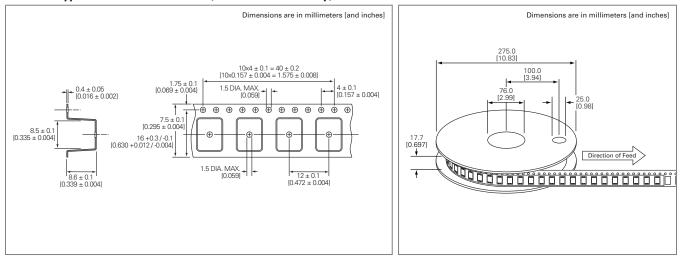
Gas Discharge Tube (GDT) Products SL1011A/B and SL1411A Series

Packaging Dimensions

For 'A' Type Axial Lead Items



For 'SM' Type Surface Mount Items (SL1411A series only)



For 'C' Type Core Items: Packed in plastic bag (500 pcs)



Part Numbering System and Ordering Information

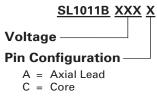
For SL1011A series:

SL1011A XXX X Voltage _____ Pin Configuration ____ A = Axial Lead

Remarks: Formed leads are available on request

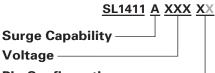
C = Core

For SL1011B series:



Remarks: Formed leads are available on request

For SL1411A series:



Pin Configuration -

A = Axial Lead C = Core

SM = Surface Mount